

AMENDMENT UNDER 37 C.F.R. § 1.116
EXPEDITED PROCEDURE
GROUP 2829
PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q74738

Chen Fung LENG, et al.

Appln. No.: 10/552,046

Group Art Unit: 2829

Confirmation No.: 6904

Examiner: Karen M KUSUMAKAR

Filed: January 9, 2007

For: MULTI-CHIP BALL GRID ARRAY PACKAGE AND METHOD OF MANUFACTURE

AMENDMENT UNDER 37 C.F.R. § 1.116

MAIL STOP AF

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated November 26, 2008, please amend the above-identified application as follows on the accompanying pages.

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